



Inventek Systems

Embedding Connectivity Everywhere

ISM14585-L35-P8-EVB

BLE 5.0 SiP

Evaluation Board User's Manual

5.0 BLE + Cortex M0 + PMU + Audio + PA + 8Mb Flash

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1 PART NUMBER DETAIL DESCRIPTION

1.1 Ordering Information

Device	Description	Standard Ordering Number
ISM14585-L35-P8-EVB Internal Antenna Evaluation Board	BLE 5.0 + Cortex M0 Module with integrated PMU, PA, 8Mb of Flash and internal antenna EVB (Evaluation Board)	ISM14585-L35-P8-EVB
ISM14585--L35-P8-EVB-W w.fl External Antenna Evaluation Board + B24P-W w.fl External Antenna	BLE 5.0 + Cortex M0 Module with integrated PMU, PA, 8Mb of Flash and w.fl external antenna EVB (Evaluation Board)	ISM14585-L35-P8-EVB-W B24P-W
Note:		
<ul style="list-style-type: none"> The Dialog DA14585-00ATDEVKT-P Development Kit – Pro Motherboard EVK must also be purchased in order to use the Inventek ISM14585 L35-P8-EVB evaluation board. There is <u>no difference in the module footprint</u> between the internal and external antenna options for the module. Pin 34, RF Out would either go to the internal antenna pad Pin 35 or out to the w.fl connector, enabling maximum performance optimization for customers that want to evaluate both antenna options without having to change their PCB layout. 		

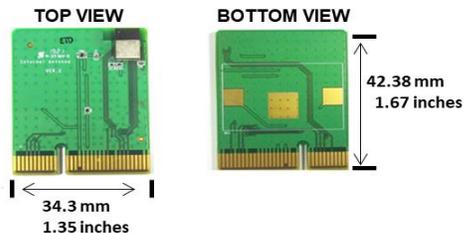
1.2 Ordering Information Configuration

Evaluation Board Ordering Number:

ISM14585-EVB-X

Antenna:

- Blank = Internal Antenna
- W = w.fl External Antenna



NOTES:

- Dialog CodeLess AT Commands also supported.
- For additional configuration options please contact Inventek Systems

2 OVERVIEW

The Inventek Systems **ISM14585-L35** SiP (System in Package), is one of the smallest, lowest power and most integrated Bluetooth® 5.0 solutions available. The **ISM14585-L35** platform is the first BLE module from Inventek's **FLEXiBLE** product family. The **ISM14585-L35** SiP is an embedded wireless Bluetooth Low Energy (BLE) IoT radio, based on the Dialog Semiconductor DA14585 radio SoC (System on Chip). The **ISM14585-L35** offers designers all the benefits of the industry-leading DA14580 technology but with even greater flexibility to create more advanced applications from the smallest footprints and power budgets.

The **ISM14585-L35** is ideal for applications such as remote controls, beacons, connected sensors and innovative medical devices. Among the new features, the **ISM14585-L35** supports Data Packet Length Extension, Link Layer Privacy v1.2, Secure Connections, Bluetooth low energy and Efficient connectable Advertising.

The **ISM14585-L35** integrated Audio Unit (AU) is equipped with a Pulse-Density Modulation (PDM) interface that can be connected to up to 2 input devices (e.g. MEMS microphones) or output devices, a PulseCode modulation (PCM) controller which provides an up to 192 kHz synchronous interface to external audio devices, ISDN circuits and serial data interfaces (I2S) and a 24-bit Sample Rate Converting unit (SRC) used to convert the sampling rate of audio samples between the various interfaces. PDM and PCM functionality can be mapped to any GPIO through the user programmable pin logic. An integrated DMA controller handles all data transfers between the AU and the RAM providing the CPU with the freedom to cope with other tasks.

The **ISM14585-L35** SiP provide smarter, more flexible, and even lower power BLE connectivity with an integrated 32bit Cortex™-M0 (16MHz), processor, an integrated PMU (Power Management Unit), an integrated PA (Power Amplifier), an integrated 128kB of ROM, 64KB OTP, 1MB SPI Flash as well as a foot print compatible options for an additional integrated 4Mb, 8Mb, or 16Mb of Flash.

The **ISM14585-L35** SiP provides a number of features and standard peripheral interfaces (see “Features” below), enabling a seamless connection to an embedded design. The **ISM14585-L35** is a very versatile SoC and is ideal for adding Bluetooth low energy to products like remote controls, proximity tags, beacons, connected medical devices and smart home nodes. The **ISM14585-L35** supports all Bluetooth developments up to and including Bluetooth 5.0.

The **ISM14585-L35** also includes 96KB of RAM, the **ISM14585-L35** has double the memory for User applications of its predecessor to take full advantage of the standard's features. The **ISM14585-L35** also includes an integrated microphone interface for voice support at no additional cost. The wide supply voltage range (0.9 –3.6 V) covering a larger choice of energy sources also enables full design flexibility.

The **ISM14585-L35** is easy to design-in and supports standalone as well as hosted applications. The **ISM14585-L35** is supported by a complete development environment with Dialog's SmartSnippets™ software that helps customers optimize software for power consumption.

The **ISM14585-L35** supports several fully qualified profiles embedded in ROM (see "Typical Applications" below), and the option of loading additional profiles into RAM. The low cost, small foot print (6.0mm x 8.6mm x 1.2mm), LGA 35 pin package and ease of design-in make the **ISM14585-L35** ideal for a wide range of embedded applications.

The **ISM14585-L35** enables wireless connectivity to the simplest existing sensor products with minimal engineering effort. **ISM14585-L35** reduces development time, lowers manufacturing costs, saves board space, simplifies certification compliance, and minimizes customer RF expertise required during development of target applications.

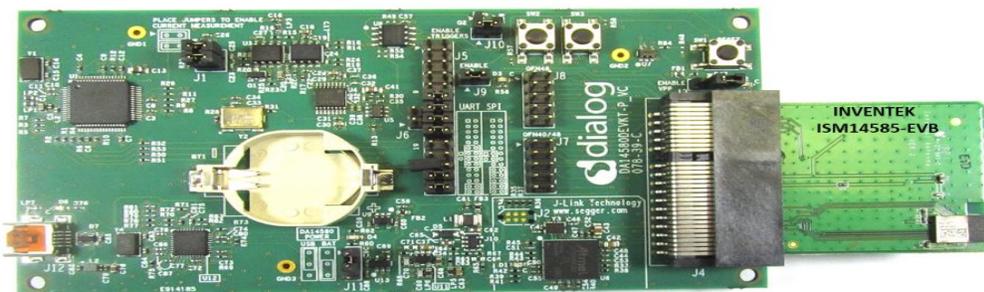
The **ISM14585-L35** provides the highest level of integration for a wireless system, with market leading and integrated BLE 5.0 technology based on Dialog's DA14585 SoC. The **ISM14585-L35** is also fully supported by Dialog's Smartbond product family Development Kit-Pro evaluation board and Dialog SmartSnippets Studio SDK.

3 ISM14585-EVB FEATURES

3.1 ISM14585-EVB Daughterboard

The **ISM14585-EVB** evaluation board is a Daughterboard that is pin to pin compatible and seamlessly interfaces to the Dialog DA14585 Development Kit-Pro Motherboard (P/N DA14585-00ATDEVKT-P), including all application support via Dialog's SDK SmartSnippets Studio and downloaded via USB (USB to UART transfer IC) to the **ISM14585-EVB**.

Dialog Dev Kit Pro Motherboard + Inventek ISM14585-EVB Daughterboard



The **ISM14585-EVB** Daughter Card Evaluation Board is a pin to pin compatible evaluation board that seamlessly interfaces to the Dialog DA14585 Development Kit-Pro Mother Board including application support via Dialog's SDK SmartSnippets Studio and downloaded via USB (USB to UART transfer IC) to the **ISM14585-EVB**.

3.2 Dialog's DA14585-00ATDEVKT-P Development Kit – Pro Motherboard EVK and SDK SmartSnippets Studio

The Dialog's SDK SmartSnippets Studio includes all of the support required for the tool chain, build system, the BLE driver and the software stack together with example applications. The SDK also runs on Windows.

The **ISM14585-EVB** provides a platform for the design and development of applications to run on the **ISM14585-L35-P8** SiP Module.

3.3 Feature Highlights:

ISM14585-L35-P8 SiP Module	The ISM14585-L35-P8 SiP Module integrates the Dialog DA14585 BLE 5.0 radio SoC, 8Mbit SPI Flash, a Cortex M0 ARM-based 32-bit 16MHz, 96kB Data/Retention SRAM, 128kB ROM. 64kB One-Time-Programmable (OTP) memory, a PMU, an Audio Unit, and a Power Amplifier.
ISM14585-L35-P8-EVB DAUGHTERBOARD	Complies with Bluetooth V5.0 solution and includes the ISM14585-L35-P8 SiP Module, integrated Antenna or the option for a w.fl RF connector.
Program & Debug Interface	Applications are downloaded to the ISM14585-L35-P8 SiP Module and debugged via the Dialog DA14585 Development Kit-Pro Motherboard (P/N DA14585-00ATDEVKT-P)
USB-Serial UART Interface	A UART on the ISM14585-L35-P8 SiP Module connects to the ISM14585-L35-P8-EVB Daughterboard which connects to the Dialog DA14585 Development Kit-Pro Motherboard. The USB-serial interface is used to enable serial communications with a PC terminal application.
Power Supply	The ISM14585-EVB Daughterboard is powered from the Dialog DA14585 Development Kit-Pro Motherboard.
Applications	<ul style="list-style-type: none"> • Voice-controlled remote controls, • Beacons, (Mult-sensor) • Wearable devices: Fitness trackers, Consumer health • Smartwatches • Human interface devices: Keyboard, Mouse • Toys • Consumer appliances.

3.4 Key Benefits

- Lowest power consumption
- Smallest system size
- Lowest system cost

3.5 Limitations

Inventek Systems products are not authorized for use in safety-critical applications (such as life support) where a failure of the Inventek Systems product would reasonably be expected to cause severe personal injury or death.

3.6 Regulatory Compliance

CE



Regulator	Status
FCC	O7P-14585
IC	10147A-14585
RoHS	Compliant

Inventek Systems FCC, IC, and CE module transmitter certifications for the **ISM14585-L35-P8** module can be used to the advantage of any manufacturer developing a product using these devices. In order to take full advantage of the certifications and remain in compliance, Developers may not interfere, modify, replace and/or enhance the SiP antenna design, layout and power settings. For FCC compliance, End Customer finished products will still need to meet the Declaration of Conformity (SDoC) requirements according to 47 CFR Chapter 1, part 15, subpart B.

The testing required for the Declaration of Conformity (SDoC) requirements is specified in sections 15.107 and 15.109. The official documents can be obtained from the U.S Government Printing Office online. U.S. Government Printing Office CFR 47.

Any changes to the Inventek certified antenna options such as a different antenna or adding an antenna diversity switch will require filing for a Class 2 permissive change. Any Class 2 permissive changes must be performed under Inventek's grant, and therefore must be done in cooperation with Inventek. In addition to this document, Inventek recommends verifying the schematic board design with Inventek Engineering once the schematic is complete for further review and validation.

If it is desired to add a connector or U.FL connector in the RF path or change the antenna to one of the same type (chip) with equal or less gain, customers can do so without re-filing. Other changes such as a different antenna or adding an antenna diversity switch will require filing for a Class 2 permissive change. Any Class 2 permissive changes must be performed under Inventek's grant, and therefore must be done in cooperation with Inventek. In addition to this document, Inventek recommends verifying the schematic board design with Inventek Engineering once the schematic is complete for further review and validation.

Inventek also provides customers additional certifications for specific countries upon request and an agreed upon service fee.

3.6.1 FCC and IC Regulatory Information

- Model: ISM14585-L35-P8
- FCC ID: 07P-14585
- IC: 10147A-14585

This module is limited to OEM installation only.

OEM integrators must ensure that the end-user has no manual instructions to remove or install the module. OEM's must comply with FCC marking regulation part 15 declaration of conformity (Section 2.925(e)).

This module is to be installed only in mobile or fixed applications (Please refer to FCC CFR 47 Part 2.1091(b) for a definition of mobile and fixed devices).

Separate approval is required for all other operating configurations, including portable configurations with respect to FCC CFR 47 Part 2.1093, and different antenna configurations.

The antennas used with this module must be installed to provide a separation distance of at least 20cm from all persons, and must not be co-located or transmit simultaneously with any other antenna or transmitter, except in accordance with FCC multi transmitter product procedures. The ISM14585-L35-P8 Module has been designed to operate with the following antennas and gains. Use with other antenna types or with these antenna types at higher gains is strictly prohibited.

Manufacturer	Type of Antenna	Model	Gain dBi	Type of Connector
Inventek	Integrated	N/A	-1	embedded
Inventek	Trace	B24P-W	3.2	w.fl

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference
- (2) This device must accept any interference received, including interference that may cause undesired operation.

Warning: Changes or modifications not expressly approved by the party responsible is prohibited.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications.

However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/ TV technician for help.

This equipment complies with FCC RF Exposure requirements and should be installed and operated with a minimum distance of 20cm between the radiator and any part of the human body.

A clearly visible label is required on the outside of the user's (OEM) enclosure with the following text:

- Contains FCC ID: O7P-14585
- Contains IC: 10147A-14585

This transmitter module is certified for FCC Part 15 operation; when installed in a host device, the host manufacturer is responsible for making sure that the host device with the transmitter installed continues to be compliant with Part 15B unintentional radiator requirements.

RSS-210/RSS-Gen Notices:

Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of this device.

L'opération est soumise aux deux conditions suivantes: (1) cet appareil ne peut pas provoquer d'interférences et (2) cet appareil doit accepter toute interférence, y compris les interférences qui peuvent causer un mauvais fonctionnement de l'appareil.

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

Sous la réglementation d'Industrie Canada, ce transmetteur radio ne peut fonctionner en utilisant une antenne d'un type et un maximum (ou moins) gain approuvés pour l'émetteur ISM14585-L35 Specification par Industrie Canada. Pour réduire le risque d'interférence aux autres utilisateurs, le type d'antenne et son gain doivent être choisis de manière que la puissance isotrope rayonnée équivalente (PIRE) ne dépasse pas ce qui est nécessaire pour une communication réussie.

The radio transmitter has been approved by Industry Canada to operate with the antenna types listed above with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet émetteur de radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antennes énumérés ci-dessus avec le gain maximal admissible et l'impédance d'antenne requise pour chaque type d'antenne indiqué. Les types d'antennes ne figurant pas dans cette liste, ayant un gain supérieur au gain maximum indiqué pour ce type, sont strictement interdites pour l'utilisation avec cet appareil.

4 Dialog SDK and Tool Chain Initialization Instructions

4.1 Go to the Dialog “**Get Support**” link :

4.1.1 <https://www.dialog-semiconductor.com/bluetooth-low-energy>

4.1.2 Scroll down to **SmartBond™ Product Portfolio** & select **DA14585**

4.2 Scroll down to “**Development Tools**”

4.2.1 Download the most recent **SmartSnippets Studio** for your OS

4.2.2 Download the most recent **SmartSnippets Studio User's Manual**

4.3 Scroll to the “**SDK**” section

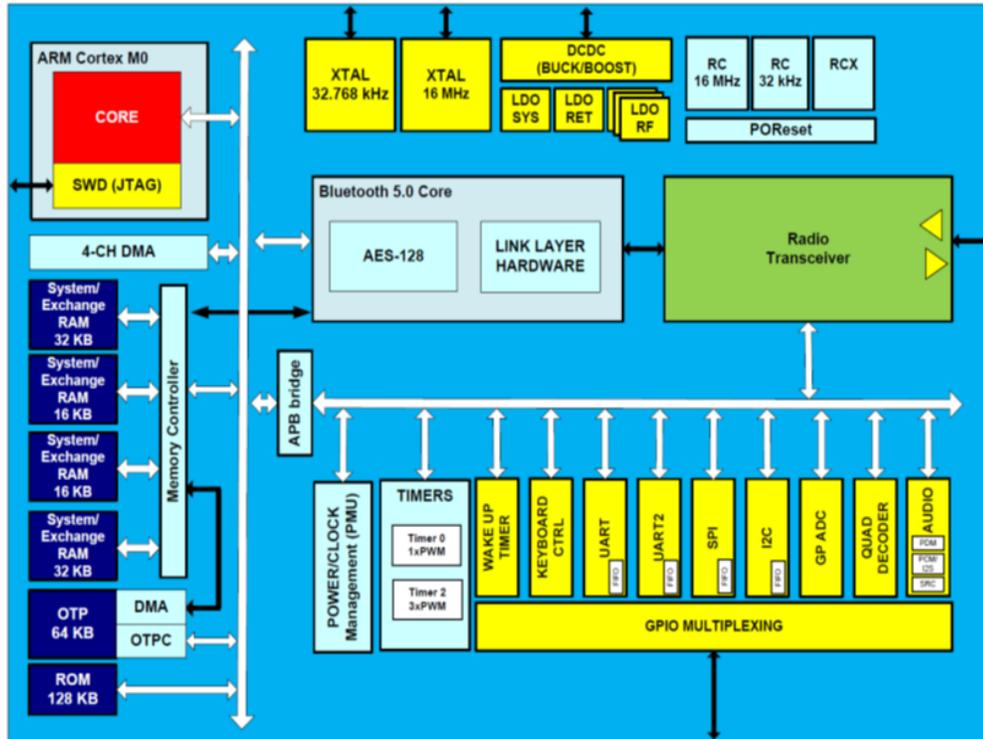
4.3.1 Download the most recent **SDK Development Kit** available.

4.3.2 Access either the Web or PDF version of the **Getting Started Guide for the Pro-Development Kit EVB for the DA14585**

This “**User Manual SmartSnippets Studio**” describes how to install SmartSnippets™ Studio on to your computer, and how to use it in combination with the SmartSnippets™ SDK, the Dialog's DA14585-00ATDEVKT-P Development Kit – Pro Motherboard and the Inventek ISM14585-EVB Daughterboard.

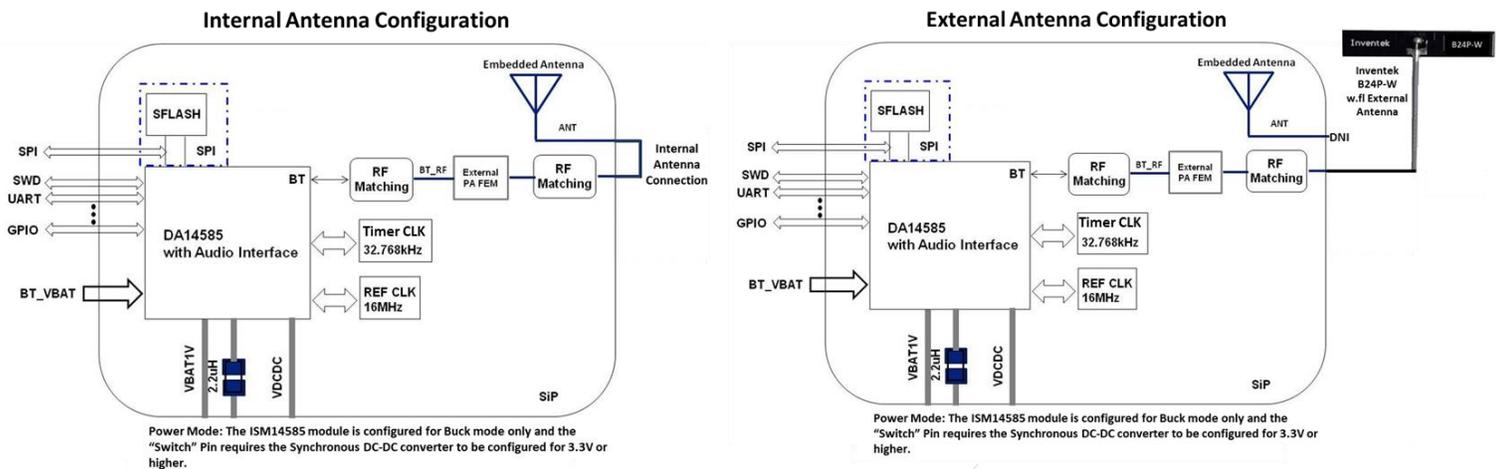
5 ISM14585-L35-P8 RADIO & MODULE BLOCK DIAGRAM

5.1 ISM14585-L35-P8 Radio Block Diagram



ISM14585-L35-P8 Radio Block Diagram (Reference the ISM14585-L35-P8 Data Sheet for details)

5.2 ISM14585-L35-P8 Module Block Diagrams



ISM14585-L35-P8 Module Block Diagrams

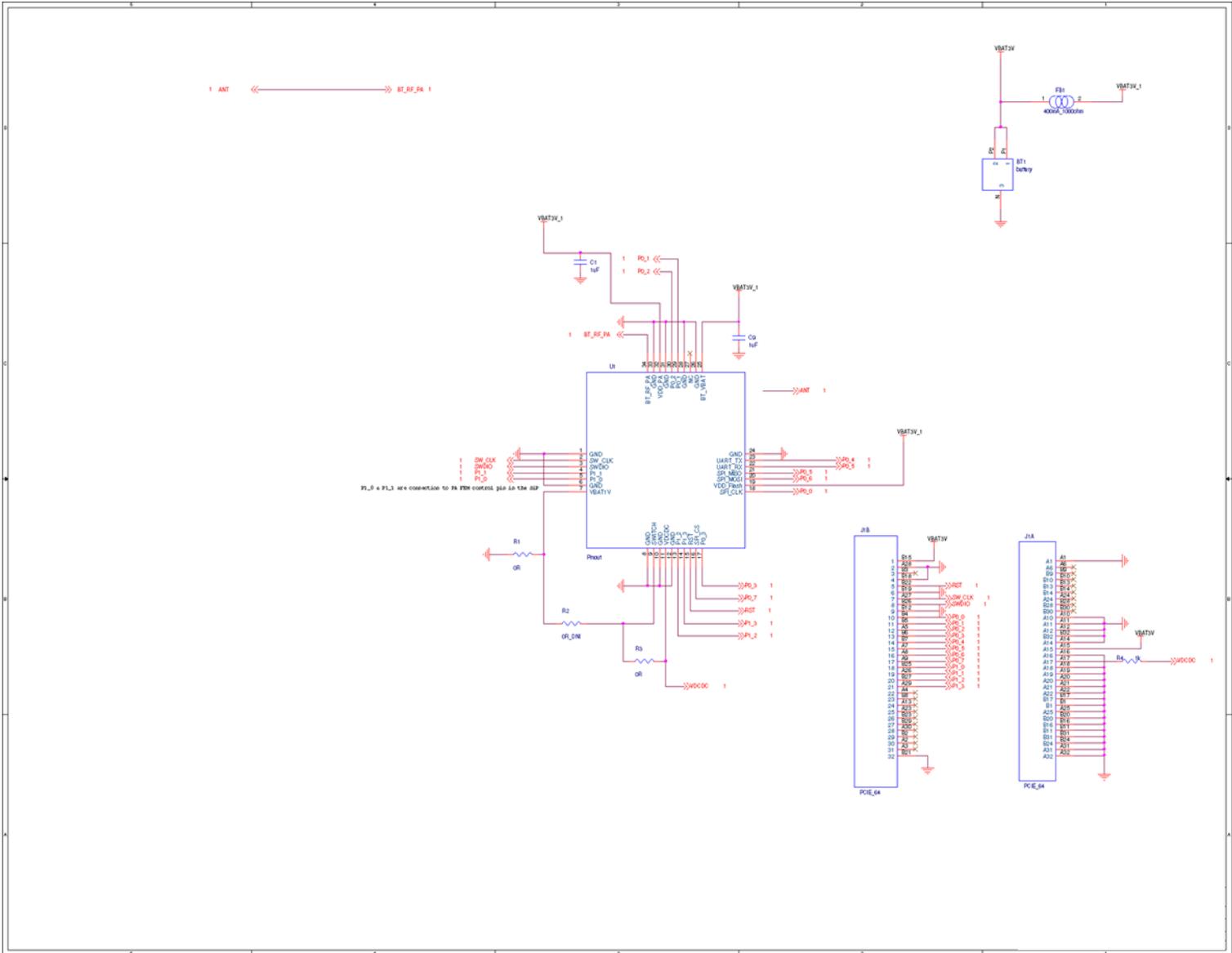
- UART Universal synchronous/asynchronous receiver transmitters
- SPI Serial Peripheral Interface
- I2C Inter-Integrated Circuit
- GPIO General-purpose input/output
- SWD Serial Wire Debug

Theory of Operation:

The functional block diagram for each antenna option for ISM14585-L35-P8 RF module is shown above. This module is a direct sequence spread spectrum transceiver operating in the 2.402 GHz to 2.480 GHz ISM band. Channels are spaced at 2 MHz intervals in the ISM band. There are a total number of 40 channels. The system operates at a chip rate of 1Mbps, a sample rate between 8 kHz and 48 kHz and a bit rate of 1000kbps. GFSK modulation is used with DSSS. An input supply of 3.0 VDC is supplied to the RF module using a battery or external power supply.

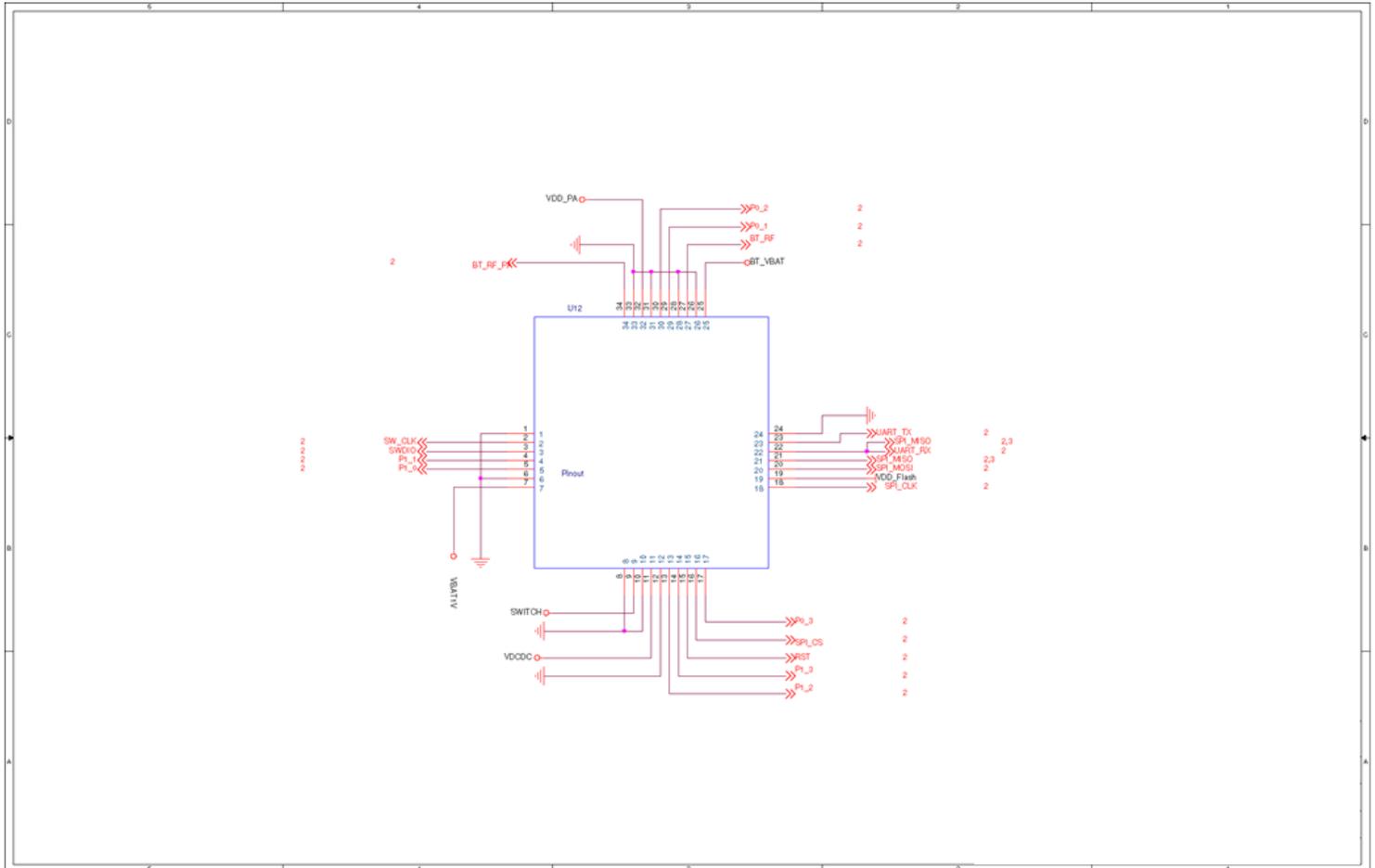
6 ANTENNA CONFIGURATION OPTIONS

6.1 Integrated Antenna



7 ISM14585-L35-P8 MODULE SCHEMATIC & PIN OUT

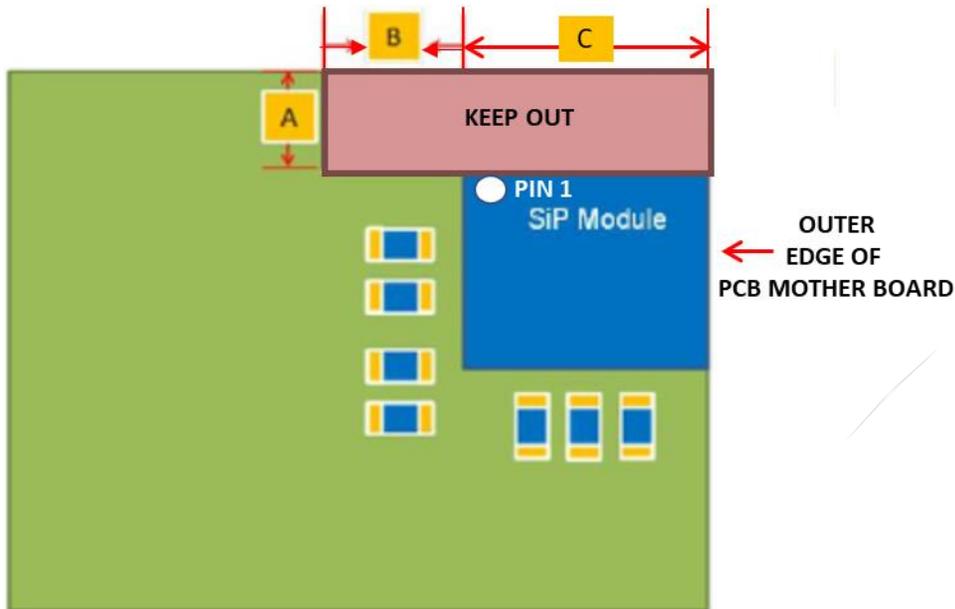
7.1 Module Pin Out



8 ISM14585 MODULE PCB INTERNAL ANTENNA LAYOUT

8.1 Configuration Example 1:

8.1.1 Top view



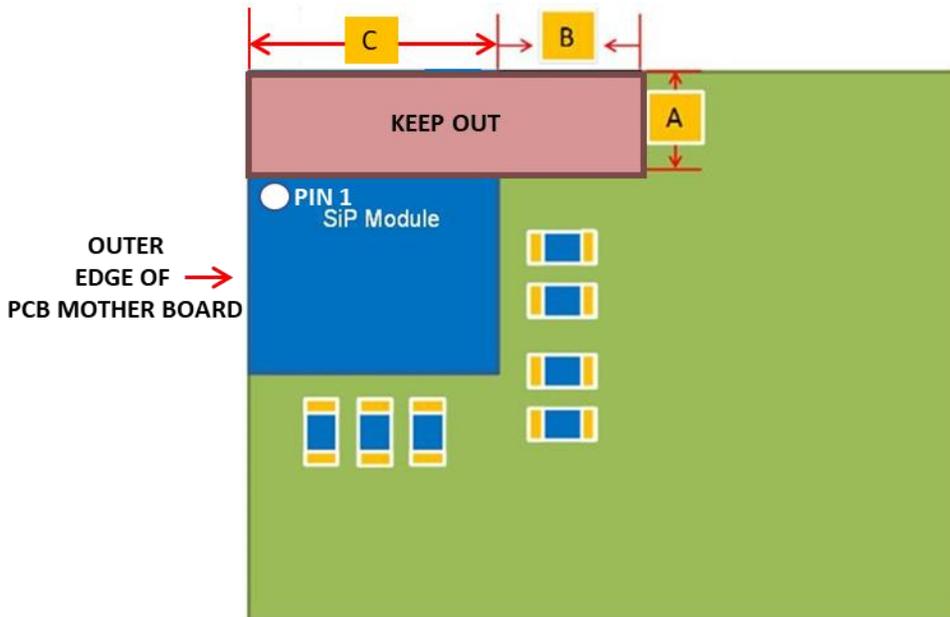
Configuration Example 1 recommended design:

- Position the ISM14585 module near the PCB edge.
- Route the keep out for 3mm
- A: 3mm typ.
- B: ≥ 3 mm typ.
- C: **KEEP OUT** extends the entire width of the module (6mm typ)
- **NOTE: There should be NO Copper in the KEEP OUT area for all Layers except for the internal RF Antenna Trace (Please reference Section 9.0).**

Parameter	Unit: mm
A	3.0 (typ.)
B	3.0 (typ.)
C	6.0 (typ)

8.2 Configuration Example 2:

8.2.1 Top View



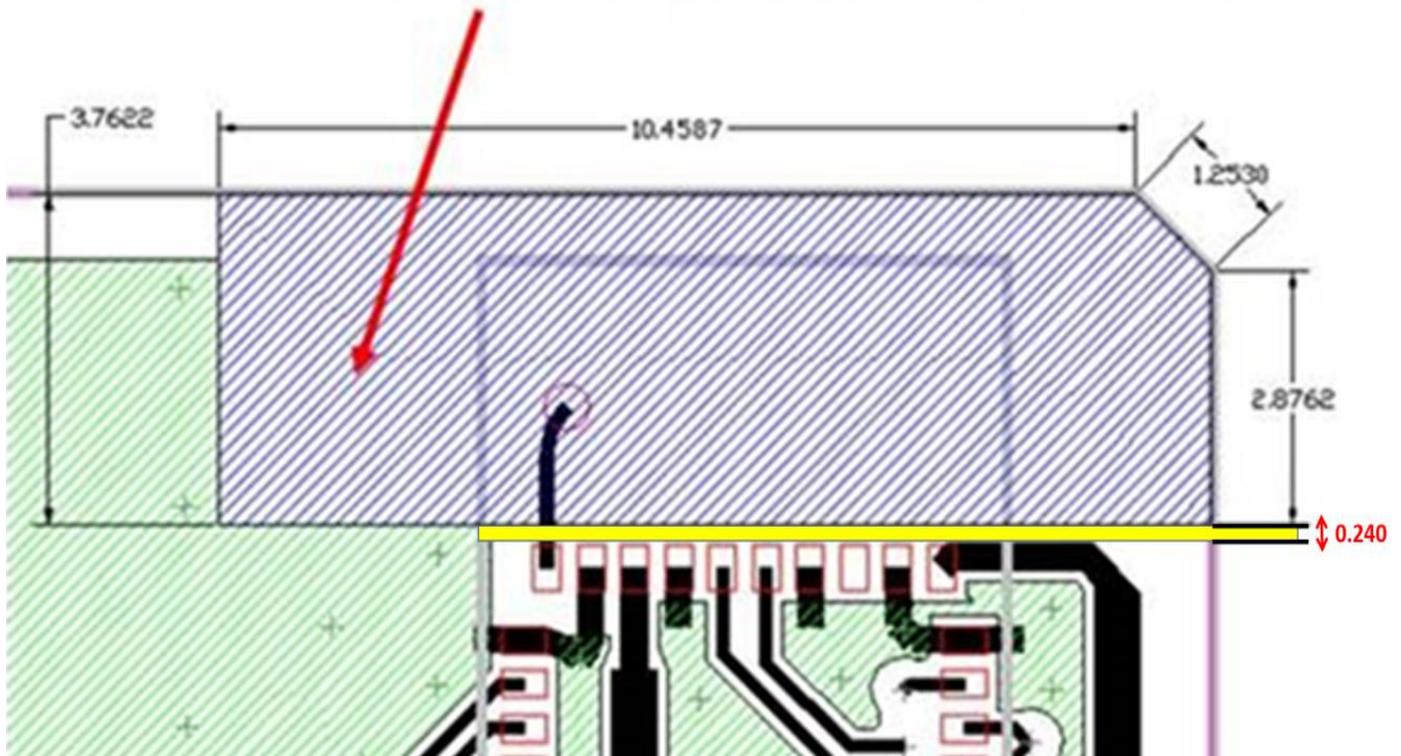
Configuration Example 2 recommended design:

- Position the ISM14585 module near the PCB edge.
- Route the keep out for 3mm
- A: 3mm typ.
- B: ≥ 3 mm typ.
- C: **KEEP OUT** extends the entire width of the module (6mm typ)
- **NOTE: There should be NO Copper in the KEEP OUT area for all Layers except for the internal RF Antenna Trace (Please reference Section 9.0).**

Parameter	Unit: mm
A	3.0 (typ.)
B	3.0 (typ.)
C	6.0 (typ)

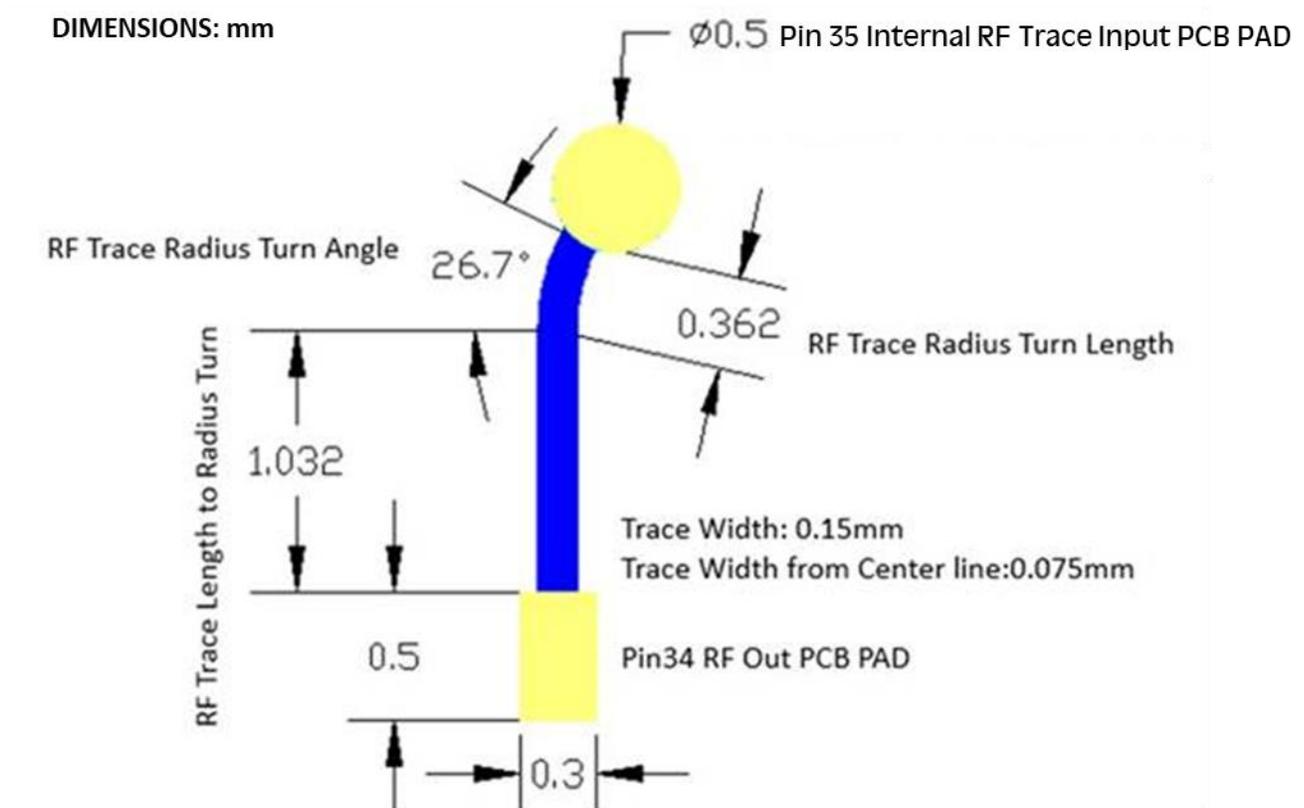
8.3 ISM14585 EVALUATION BOARD WITH MODULE KEEP OUT EXAMPLE

Antenna Keep out area:
it doesn't have any cu plane in keep out area



NOTE: THE DISTANCE BETWEEN THE TOP ROW OF PADS AND THE KEEP OUT AREA IS 0.240mm AND THIS AREA IS ALSO TREATED AS KEEP OUT

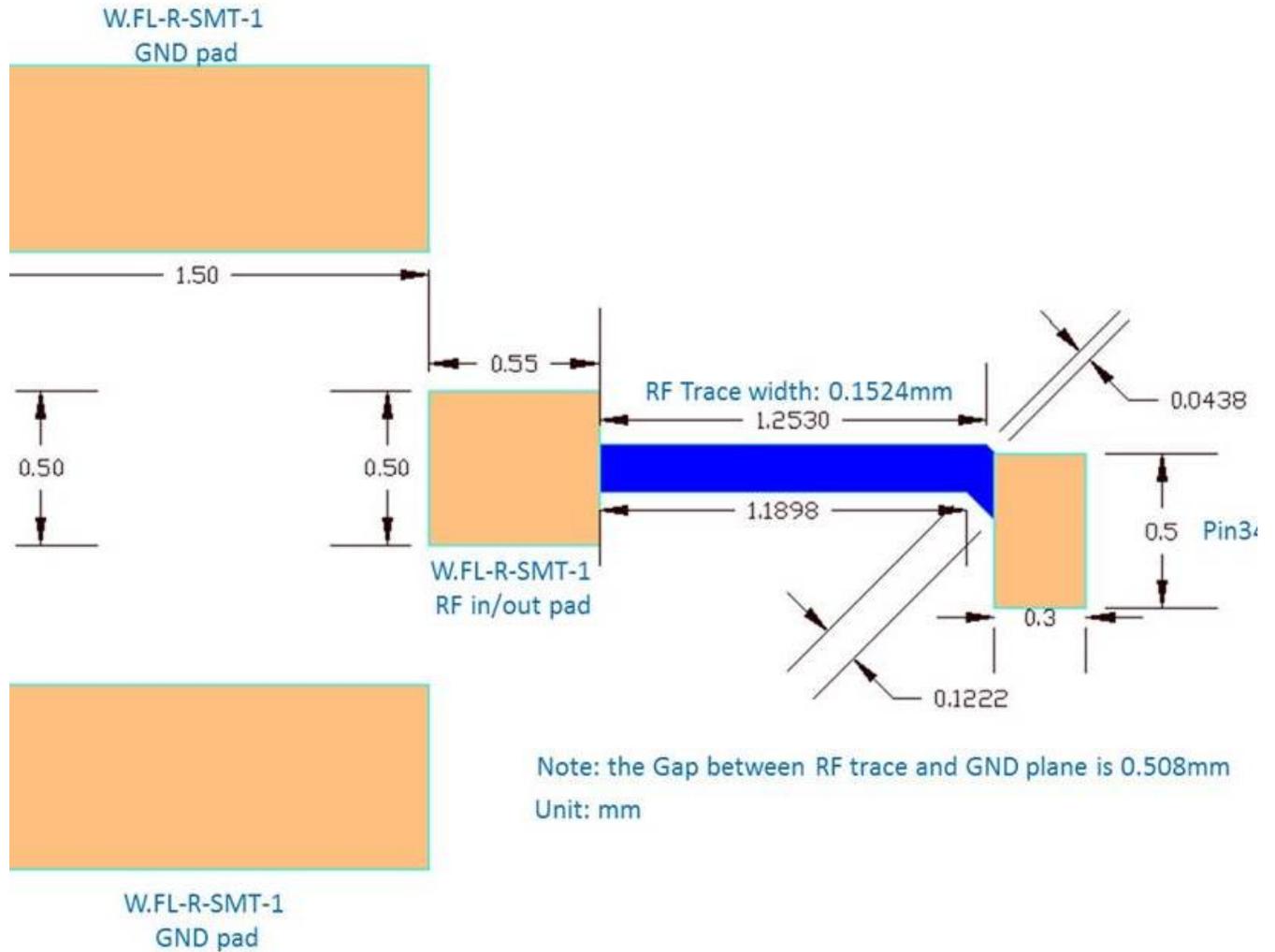
8.4 ISM14585 RF OUTPUT TO INTERNAL ANT. REQUIRED RF TRACE LAYOUT



NOTE: Please be sure the Trace Width between the Pin 34 PAD and Pin 35 PAD is 0.15mm wide.

9 ISM14585 MODULE EXTERNAL ANTENNA LAYOUT

9.1 W.FL EXTERNAL ANTENNA REQUIRED LAYOUT



10 REVISION CONTROL

Document: ISM14585-EVB	ISM14585 Evaluation Board
External Release	DOC-DS-14585-201911-3.5

Date	Author	Revision	Comment
5/05/2018	AS	1.0	Preliminary
7/04/2019	AS	2.0	Schematics Update
9/17/2019	AS	2.5	Antenna Keep Out and Trace Layout Updated
10/4/19	AS	3.0	w.fl external antenna required layout
11/1/19	AS	3.1	Updated Internal Antenna RF Trace layout
11/19/19	AS	3.5	Added Cert IDs & updated Dialog SDK Tool Chain Instructions

11 CONTACT INFORMATION:

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